

# HIGH-PIN-COUNT HEADER

Addressing space constraints in **high-density applications** with a **compact, pluggable** header that delivers reliable connections in harsh environments.



## DESIGN FLEXIBILITY AND FUNCTIONALITY

- › Configurations and options that cater to various programs and volumes.



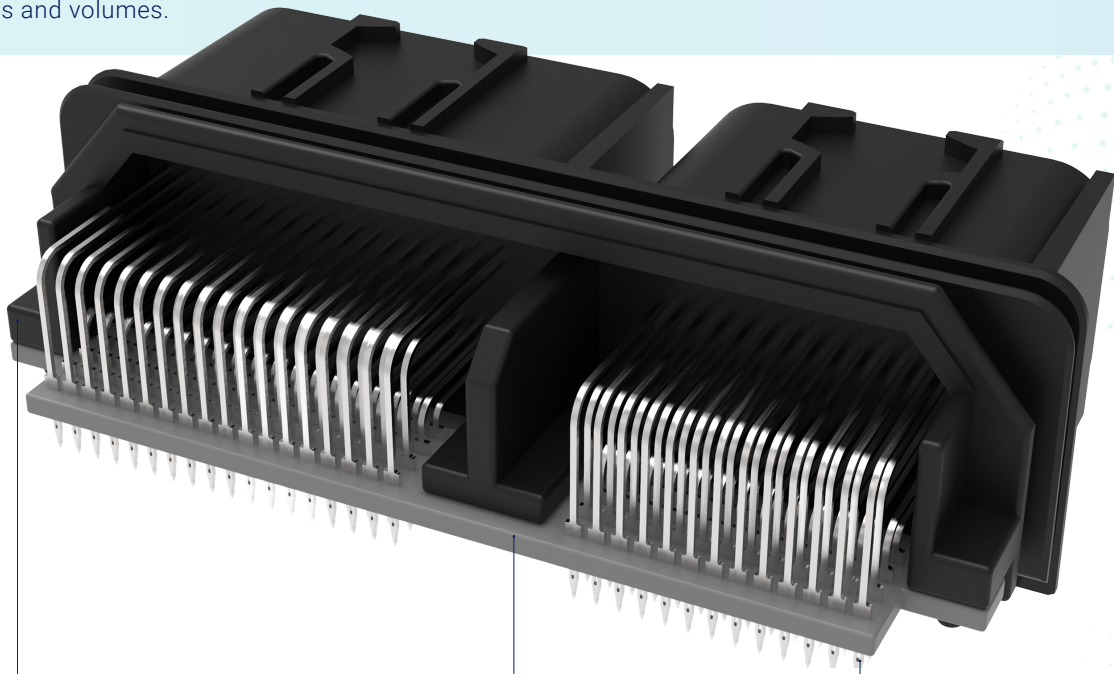
## AUTOMOTIVE-COMPLIANT

- › Application specification: SAE/USCAR-2- and LV214-compliant.



## ENVIRONMENTALLY FRIENDLY

- › Innovative tooling process adopted to reduce wastage.



## MAIN HOUSING FOR STANDARD CONNECTOR

- › Open standard interface with customization.
- › Ideal for tight packaging, high pin count and high-density applications.
- › Supports different design configurations.
- › Provides manufacturing flexibility and cost efficiency.
- › Application specification: SAE/USCAR-2- and LV214 compliant.

## KEEPER PLATE FOR PIN POSITIONING

- › Up to 200 pin counts.
- › Up to 4 rows.
- › 1.8mm pitch for signal pins.

## 0.4 EON / 0.64 EON PRESS-FIT PINS

- › Mix of signal (0.5 x 0.4mm) and power (1.2 x 0.6mm) terminals.
- › Automotive-approved Press-Fit technology: 0.4 EON or 0.64 EON.
- › Option for IndiCoat™ plating: a whisker mitigation plating technology developed by Interplex.
- › Automotive-approved plating: Sn, Ag and Au in the connector interface.

NEED A CUSTOMIZED SOLUTION?

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